

# Low Voltage Hex Inverter 74LVX04

#### **General Description**

The LVX04 contains six inverters. The inputs tolerate voltages up to 6.5 V allowing the interface of 5 V systems to 3 V systems.

#### **Features**

- Input Voltage Level Translation From 5 V to 3 V
- Ideal for Low Power/Low Noise 3.3 V Applications
- Guaranteed Simultaneous Switching Noise Level and Dynamic Threshold Performance
- This is a Pb-Free and Halide Free Device

#### **Logic Symbol**

## 

IEEE/IEC

Figure 1. Logic Symbol



TSSOP-14 WB CASE 948G

#### **MARKING DIAGRAM**

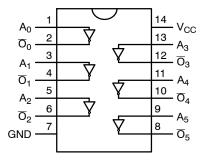


XXXXX = Specific Device Code
A = Assembly Location
L = Wafer Lot

L = Water Lot
Y = Year
W = Work Week
= Pb-Free Package

(Note: Microdot may be in either location)

#### **CONNECTION DIAGRAM**



#### **PIN DESCRIPTION**

Pin Names	Description
A <sub>n</sub>	Inputs
Ō <sub>n</sub>	Outputs

#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 3 of this data sheet.

#### 74LVX04

#### **MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	DC Supply Voltage	-0.5 to +6.5	V
I <sub>IK</sub>	DC Input Diode Current, V₁ = −0.5 V	-20	mA
VI	DC Input Voltage	-0.5 to +6.5	V
I <sub>OK</sub>	DC Output Diode Current $V_{O} = -0.5 \text{ V}$ $V_{O} = V_{CC} + 0.5 \text{ V}$	-20 +20	mA
Vo	DC Output Voltage	-0.5 to V <sub>CC</sub> + 0.5	V
Io	DC Output Source or Sink Current	±25	mA
I <sub>CC</sub> or I <sub>GND</sub>	DC V <sub>CC</sub> or Group Current	±50	mA
T <sub>STG</sub>	Storage Temperature	−65 to +150	°C
$P_{D}$	Power Dissipation	833	mW

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

### **RECOMMENDED OPERATING CONDITIONS** (Note 1)

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	Supply Voltage	2.0 to 3.6	V
V <sub>I</sub>	Input Voltage	0 to 5.5	V
Vo	Output Voltage	0 to V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature	-40 to 85	°C
$V_{\Delta} T_{\Delta} V$	Input Rise or Fall Rate	0 to 100	ns/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

#### DC ELECTRICAL CHARACTERISTICS

					T <sub>A</sub> = 25°C			C to +85°C	
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Min	Тур	Max	Min	Max	Unit
V <sub>IH</sub>	HIGH Level Input	2.0		1.5	-	-	1.5	-	V
	Voltage	3.0		2.0	-	-	2.0	-	
		3.6		2.4	-	-	2.4	-	
V <sub>IL</sub>	LOW Level Input	2.0		-	-	0.5	-	0.5	V
	Voltage	3.0		-	-	0.8	-	0.8	
		3.6		-	-	0.8	-	0.8	
V <sub>OH</sub>	HIGH Level Output Voltage	2.0	$V_{IN} = V_{IL} \text{ or } V_{IH},$ $I_{OH} = -50 \mu A$	1.9	2.0	-	1.9	-	V
		3.0	$V_{IN} = V_{IL} \text{ or } V_{IH},$ $I_{OH} = -50 \mu A$	2.9	3.0	_	2.9	-	
			$V_{IN} = V_{IL}$ or $V_{IH}$ , $I_{OH} = -4$ mA	2.58	-	_	2.48	-	
V <sub>OL</sub>	LOW Level Output Voltage	2.0	$V_{IN} = V_{IL} \text{ or } V_{IH},$ $I_{OL} = 50 \mu A$	-	0.0	0.1	-	0.1	V
		3.0	$V_{IN} = V_{IL} \text{ or } V_{IH},$ $I_{OL} = 50 \mu A$	-	0.0	0.1	-	0.1	
			$V_{IN} = V_{IL}$ or $V_{IH}$ , $I_{OL} = 4$ mA	-	-	0.36	-	0.44	
I <sub>IN</sub>	Input Leakage Current	3.6	V <sub>IN</sub> = 5.5 V or GND	-	-	±0.1	-	±1.0	μΑ
I <sub>CC</sub>	Quiescent Supply Current	3.6	V <sub>IN</sub> = V <sub>CC</sub> or GND	-	-	2.0	-	20.0	μΑ

<sup>1.</sup> Unused inputs must be held HIGH or LOW. They may not float.

#### 74LVX04

#### NOISE CHARACTERISTICS (Note 2)

				T <sub>A</sub> = 25°C		
Symbol	Parameter	V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Тур	Limits	Unit
V <sub>OLP</sub>	Quiet Output Maximum Dynamic V <sub>OL</sub>	3.3	50	0.3	0.5	V
V <sub>OLV</sub>	Quiet Output Minimum Dynamic V <sub>OL</sub>	3.3	50	-0.3	-0.5	V
V <sub>IHD</sub>	Minimum HIGH Level Dynamic Input Voltage	3.3	50	-	2.0	V
$V_{ILD}$	Maximum LOW Level Dynamic Input Voltage	3.3	50	-	0.8	V

<sup>2.</sup> Input =  $t_f = 3 \text{ ns}$ 

#### **AC ELECTRICAL CHARACTERISTICS**

				T <sub>A</sub> = 25°C		T <sub>A</sub> = -40°C to +85°C			
Symbol	Parameter	V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Тур	Max	Min	Max	Unit
t <sub>PLH</sub> ,	Propagation Delay Time	2.7	15	-	5.4	10.1	1.0	12.5	ns
t <sub>PHL</sub>			50	-	7.9	13.6	1.0	16.0	
		$3.3 \pm 0.3$	15	-	4.1	6.2	1.0	7.5	
			50	-	6.6	9.7	1.0	11.0	
t <sub>OSLH</sub> ,	Outpu to Output Skew	2.7	50	-	-	1.5	-	1.5	ns
toshl	(Note 3)	3.3		-	-	1.5	-	1.5	

<sup>3.</sup> Parameter guaranteed by design  $t_{OSLH} = |t_{PLHm} - t_{PLHn}|$ ,  $t_{OSHL} = |t_{PHLm} - t_{PHLn}|$ 

#### **CAPACITANCE**

		T <sub>A</sub> = 25°C		$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$			
Symbol	Parameter	Min	Тур	Max	Min	Max	Unit
C <sub>IN</sub>	Input Capacitance	-	4	10	-	10	pF
C <sub>PD</sub>	Power Dissipation Capacitance (Note 4)	-	18	-	-	-	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

### $I_{CC}$ (opr.) = $C_{PD} \times V_{CC} \times f_{IN} \times I_{CC} / 6$ (per Gate).

#### **ORDERING INFORMATION**

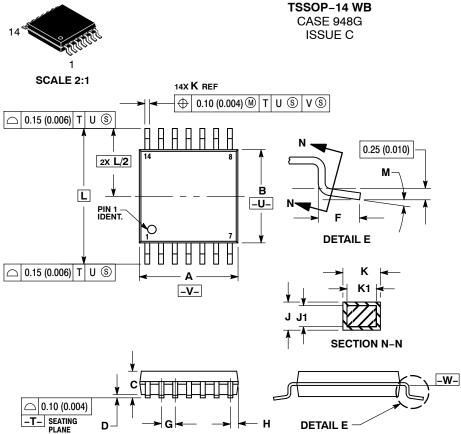
Device Order Number	Top Marking	Package Type	Shipping <sup>†</sup>
74LVX04MTCX	LVX	TSSOP-14BW	2,500 /
	04	(Pb-Free, Halide Free)	Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <a href="https://example.com/BRD8011/D">BRD8011/D</a>.

<sup>4.</sup> C<sub>PD</sub> is defined as the value of the internal equivalent capacitance, which is calculated from the operating current consumption without load. Average operating current can be obtained from the equation:

**DATE 17 FEB 2016** 





- NOTES.

  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

  2. CONTROLLING DIMENSION: MILLIMETER.

  3. DIMENSION A DOES NOT INCLUDE MOLD
- FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
  DIMENSION B DOES NOT INCLUDE
- INTERLEAD FLASH OR PROTRUSION.
  INTERLEAD FLASH OR PROTRUSION SHALL
- INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.

  DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.

  TERMINAL NUMBERS ARE SHOWN FOR DEEEDENIC OMITY.
- REFERENCE ONLY.
  DIMENSION A AND B ARE TO BE
- DETERMINED AT DATUM PLANE -W-.

	MILLIN	IETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	4.90	5.10	0.193	0.200
В	4.30	4.50	0.169	0.177
С		1.20		0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65	BSC	0.026 BSC	
Н	0.50	0.60	0.020	0.024
J	0.09	0.20	0.004	0.008
J1	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K1	0.19	0.25	0.007	0.010
L	6.40	BSC	0.252 BSC	
М	0°	8 °	0 °	8 °

#### **GENERIC MARKING DIAGRAM\***



= Assembly Location

L = Wafer Lot = Year

= Work Week W = Pb-Free Package

(Note: Microdot may be in either location)

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

#### **RECOMMENDED SOLDERING FOOTPRINT\***

<b>-</b>	7.06
1	
	-
	U 0.65 PITCH
<b>↓</b> □	The state of the s
14X 0.36	<del></del>
0.36 - 1.26	DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	TSSOP-14 WB		PAGE 1 OF 1		

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